PS2841-4A,PS2841-4B

R08DS0157EJ0101
Rev.1.01
Feb 25, 2020

WORLD'S SMALLEST CLASS, FOUR CHANNELS 12-PIN ULTRA SHRINK SOP PHOTOCOUPLER

DESCRIPTION

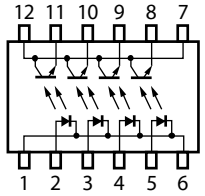
The PS2841-4A and PS2841-4B are optically coupled isolators containing GaAs light emitting diodes and NPN silicon phototransistors.
These products include four channels in a single package for high-density mounting applications.
The PS2841-4A and PS2841-4B are the world's smallest class of photocouplers and realize about 50% reduction in mounting area compared with the PS280x and PS281x Series.

FEATURES

- Ultra small and thin package
  (12-pin ultra shrink SOP, Pin pitch 0.8 mm, 4.4 (L) × 5.6 (W) × 2.5 (H))
- Common lead PS2841-4A: cathode, collector common
  PS2841-4B: anode, collector common
- High current transfer ratio (CTR = 200% TYP. @ I_F = 1mA)
- High isolation voltage (BV = 1 500 Vr.m.s.)
- Pb-Free product
- Ordering number of tape product:
  PS2841-4A-F3: 2 500 pcs/reel
  PS2841-4B-F3: 2 500 pcs/reel
- Safety standards
  - UL approved: UL1577, Single protecion

PIN CONNECTIONS
(Top View)

PS2841-4A



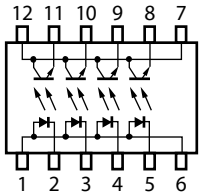
Channel	Anode	Cathode	Emitter	Collector
1 ch	2	1, 6 common	11	7, 12 common
2 ch	3	1, 6 common	10	7, 12 common
3 ch	4	1, 6 common	9	7, 12 common
4 ch	5	1, 6 common	8	7, 12 common

APPLICATIONS

- Programmable logic controllers (PLCs)
- Input and output for function automation
- Hybrid IC

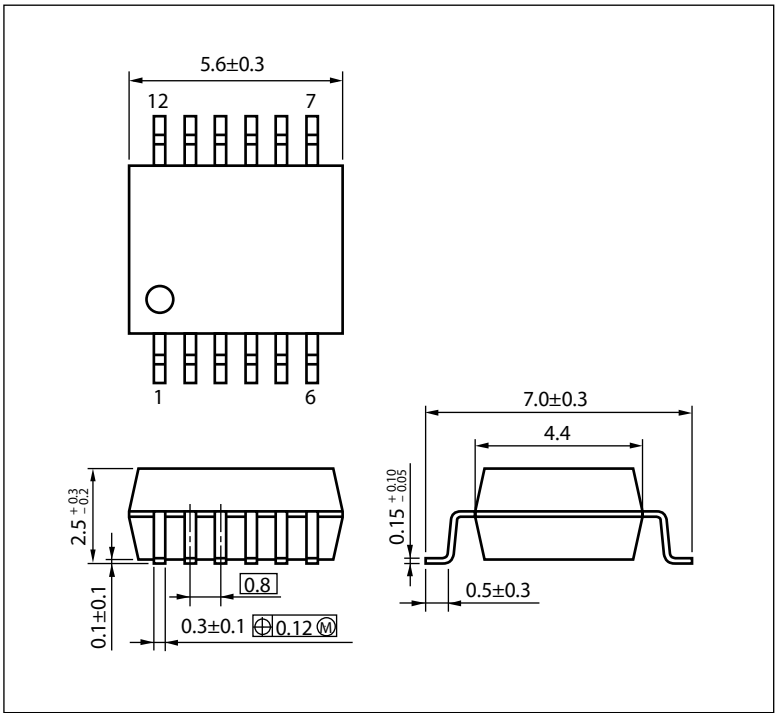
PIN CONNECTIONS
(Top View)

PS2841-4B



Channel	Anode	Cathode	Emitter	Collector
1 ch	1, 6 common	2	11	7, 12 common
2 ch	1, 6 common	3	10	7, 12 common
3 ch	1, 6 common	4	9	7, 12 common
4 ch	1, 6 common	5	8	7, 12 common

PACKAGE DIMENSIONS (UNIT: mm)

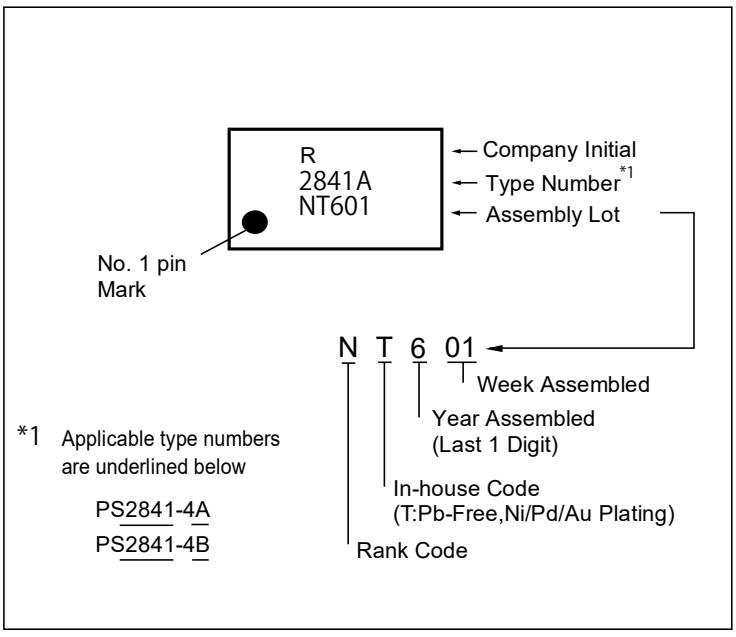


PHOTOCOUPLER CONSTRUCTION

Parameter	Unit (MIN.)
Air Distance	4.0 mm
Creepage Distance	4.0 mm
Isolation Thickness	0.4 mm

Weight (12-pin SSOP) : 0.14 g (typ.)

MARKING EXAMPLE



ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number *1
PS2841-4A	PS2841-4A-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products (UL approved)	PS2841-4A
PS2841-4A-F3	PS2841-4A-F3-AX		Embossed Tape 2 500 pcs/reel		
PS2841-4B	PS2841-4B-AX		20 pcs (Tape 20 pcs cut)		PS2841-4B
PS2841-4B-F3	PS2841-4B-F3-AX		Embossed Tape 2 500 pcs/reel		

Note: *1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	I_F	20	mA/ch
	Reverse Voltage	V_R	6	V
	Power Dissipation Derating	ΔI_F /°C	0.2	mA /°C
	Peak Forward Current *1	I_{FP}	0.5	A/ch
Transistor	Collector to Emitter Voltage	V_{CEO}	70	V
	Emitter to Collector Voltage	V_{ECO}	5	V
	Collector Current	I_C	20	mA/ch
	Power Dissipation Derating	ΔP_C/°C	0.4	mW/°C
	Power Dissipation	P_C	40	mW/ch
Isolation Voltage *2		BV	1 500	Vr.m.s.
Operating Ambient Temperature		T_A	–40 to +100	°C
Storage Temperature		T_{stg}	–55 to +125	°C

Notes: *1. PW = 100 μs, Duty Cycle = 1%

*2. AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output.
Pins 1-6 shorted together, 7-12 shorted together.

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V_F	I_F = 1 mA	0.9	1.1	1.2	V
	Reverse Current	I_R	V_R = 5 V			10	μA
	Terminal Capacitance	C_t	V = 0 V, f = 1 MHz		15		pF
Transistor	Collector to Emitter Current	I_{CEO}	I_F = 0 mA, V_{CE} = 24 V			100	nA
Coupled	Current Transfer Ratio (I_C/I_F)	CTR	I_F = 1 mA, V_{CE} = 0.4 V	100	200	400	%
	Optical Leakage Current *1 (1 to 2-ch, 2 to 3-ch, 3 to 4-ch)	I_L	I_F = 5 mA, V_{CE} = 24 V			100	nA
	Collector Saturation Voltage	$V_{CE (sat)}$	I_F = 1 mA, I_C = 0.2 mA		0.13	0.3	V
	Isolation Resistance	R_{I-O}	V_{I-O} = 1 kV$_{DC}$	10^{11}			Ω
	Isolation Capacitance	C_{I-O}	V = 0 V, f = 1 MHz		0.4		pF
	Turn-on Time *2	t_{on}	V_{CC} = 5 V, I_F = 1 mA, R_L = 5 kΩ		20		μs
	Turn-off Time *2	t_{off}			110		

Notes: *1. The optically induced leakage current is current which can be measured at transistor if LED = ”ON” and LED = ”OFF”.

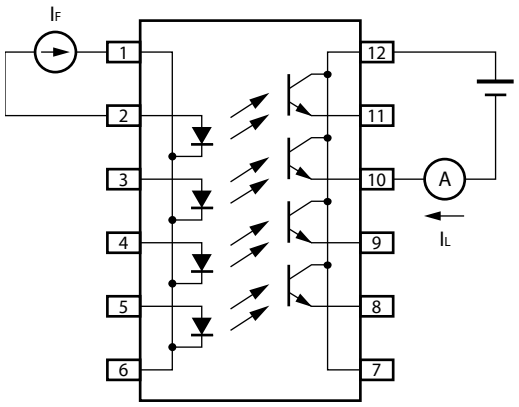
LED of channel 1 is switched to ”ON”.

At Tr-output of channel 2 a voltage is applied and one can measure a current between emitter and collector.

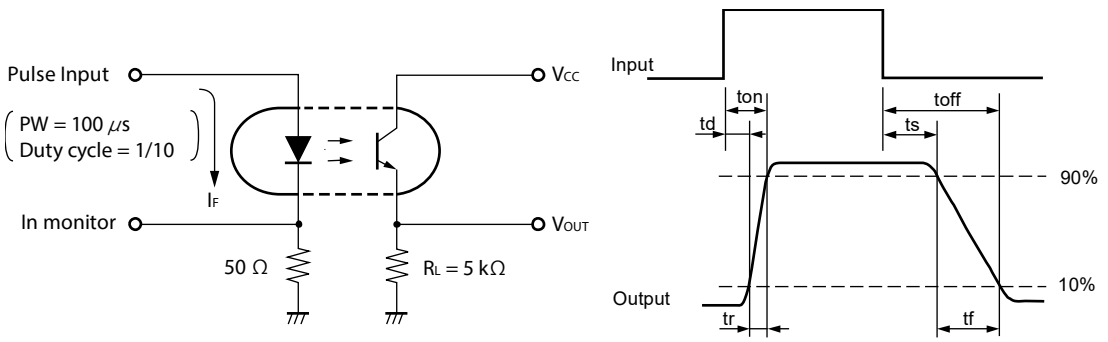
This is leakage current (at I_F = 5 mA, V_{CEO} = 24 V).

Measurement circuits for optical leakage current

E.g. : In the case of 1 to 2-ch (PS2841-4A)

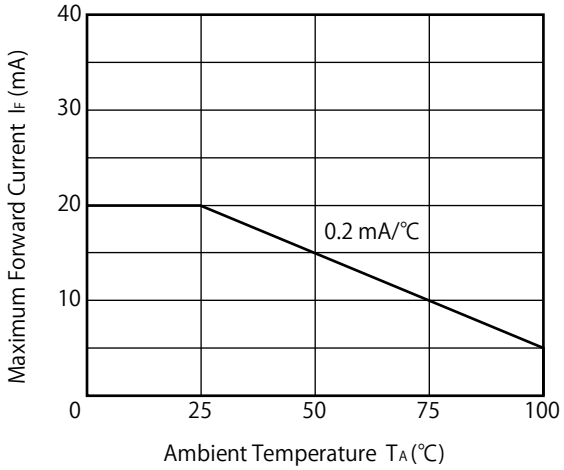


*2. Test circuit for switching time

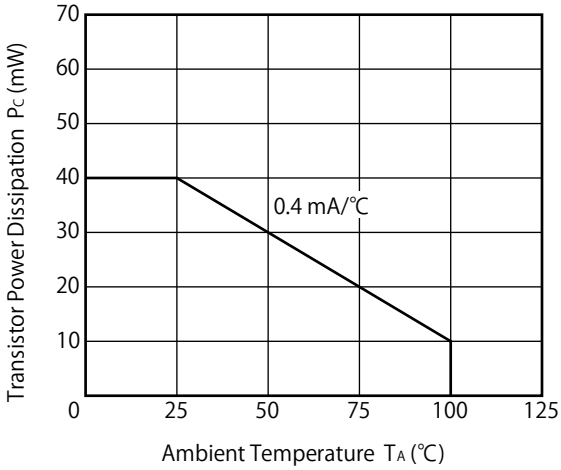


TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)

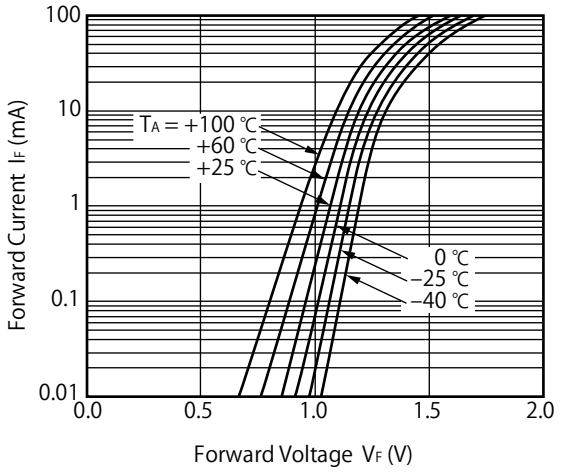
MAXIMUM FORWARD CURRENT vs. AMBIENT TEMPERATURE



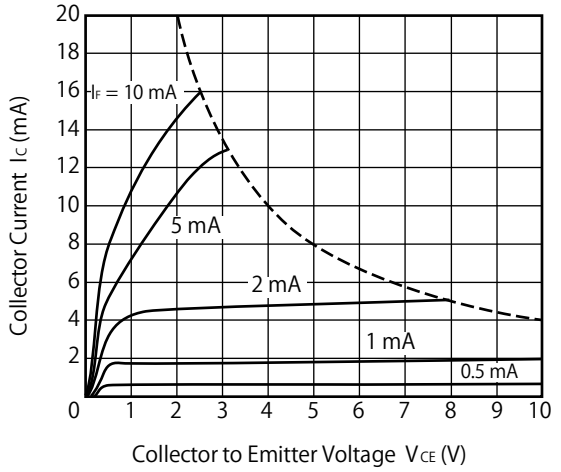
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



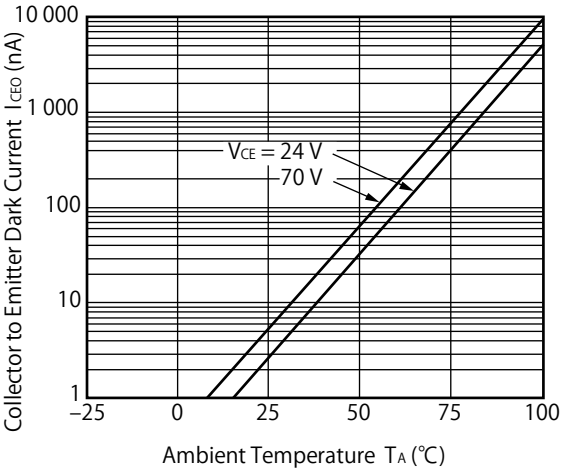
FORWARD CURRENT vs. FORWARD VOLTAGE



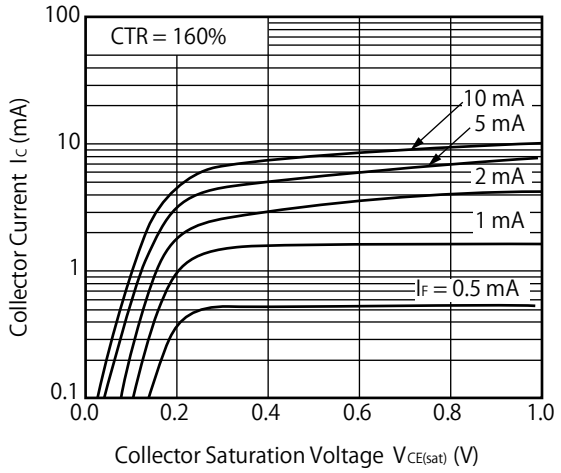
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE

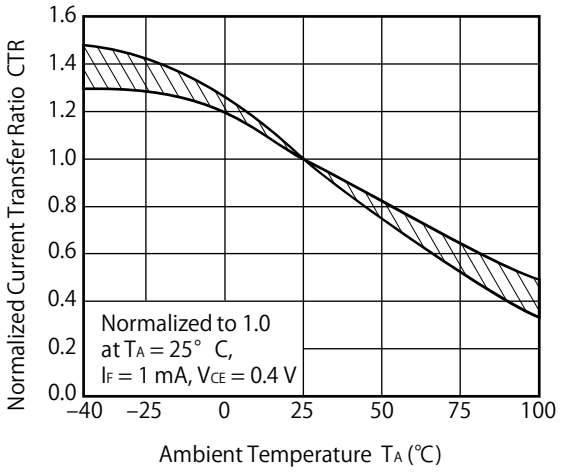


COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE

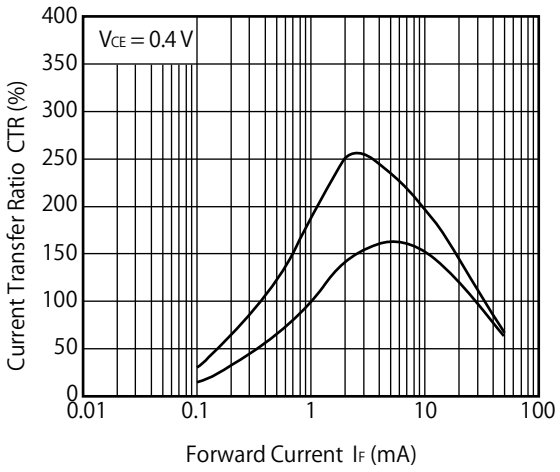


Remark The graphs indicate nominal characteristics.

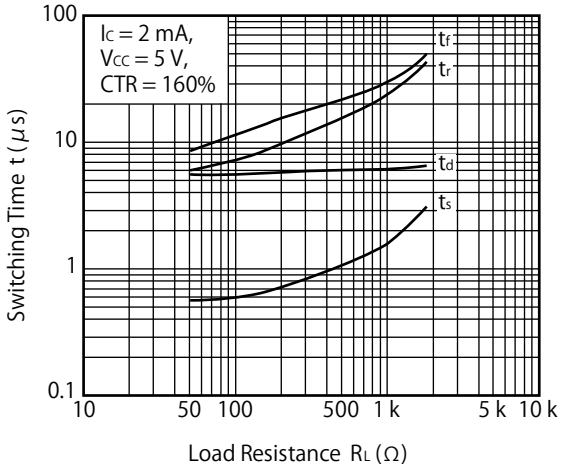
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



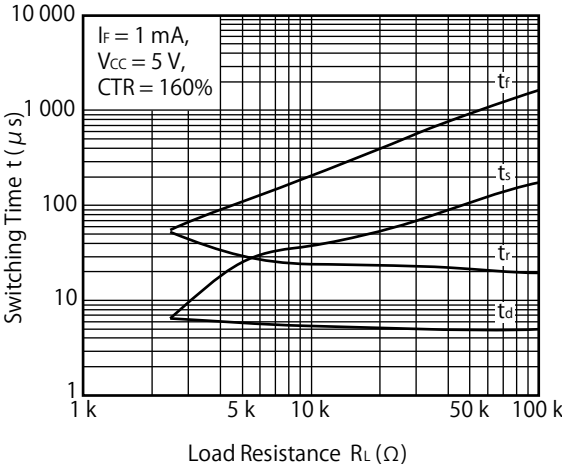
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



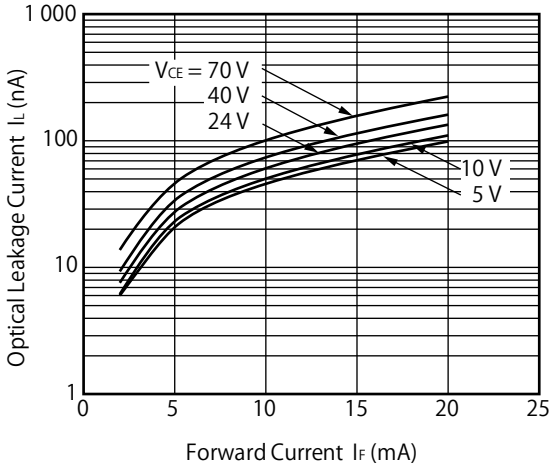
SWITCHING TIME vs. LOAD RESISTANCE



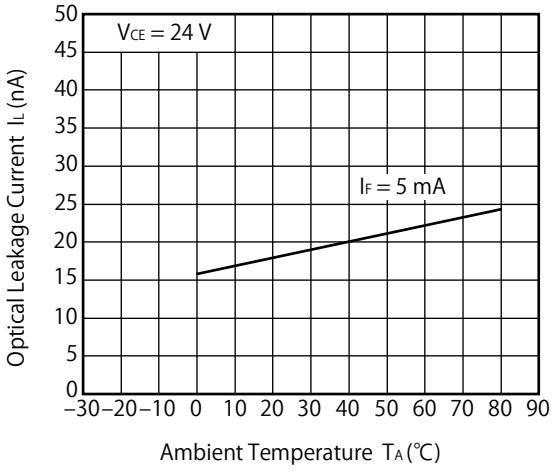
SWITCHING TIME vs. LOAD RESISTANCE



OPTICAL LEAKAGE CURRENT vs. FORWARD CURRENT



OPTICAL LEAKAGE CURRENT vs. AMBIENT TEMPERATURE

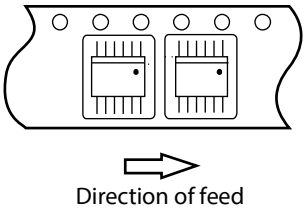


Remark The graphs indicate nominal characteristics.

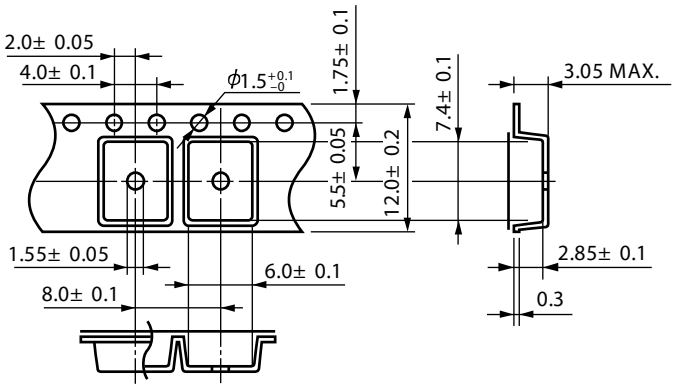
TAPING SPECIFICATIONS (UNIT: mm)

Tape Direction

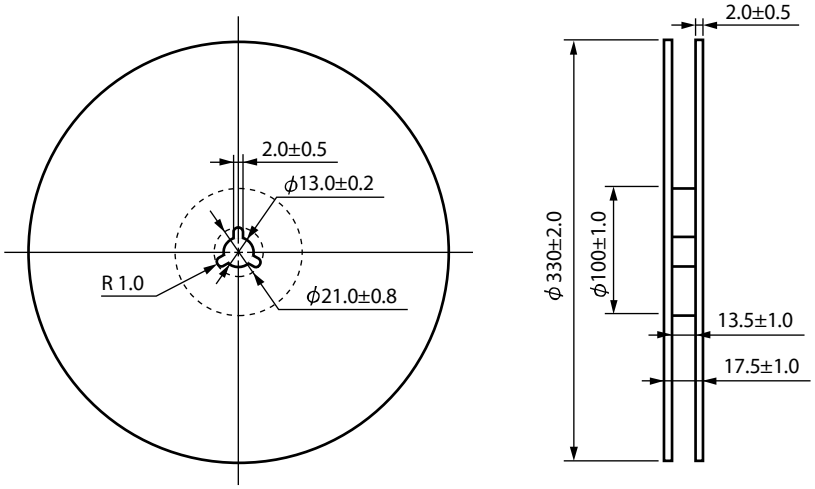
PS2841-4A-F3
PS2841-4B-F3



Outline and Dimensions (Tape)

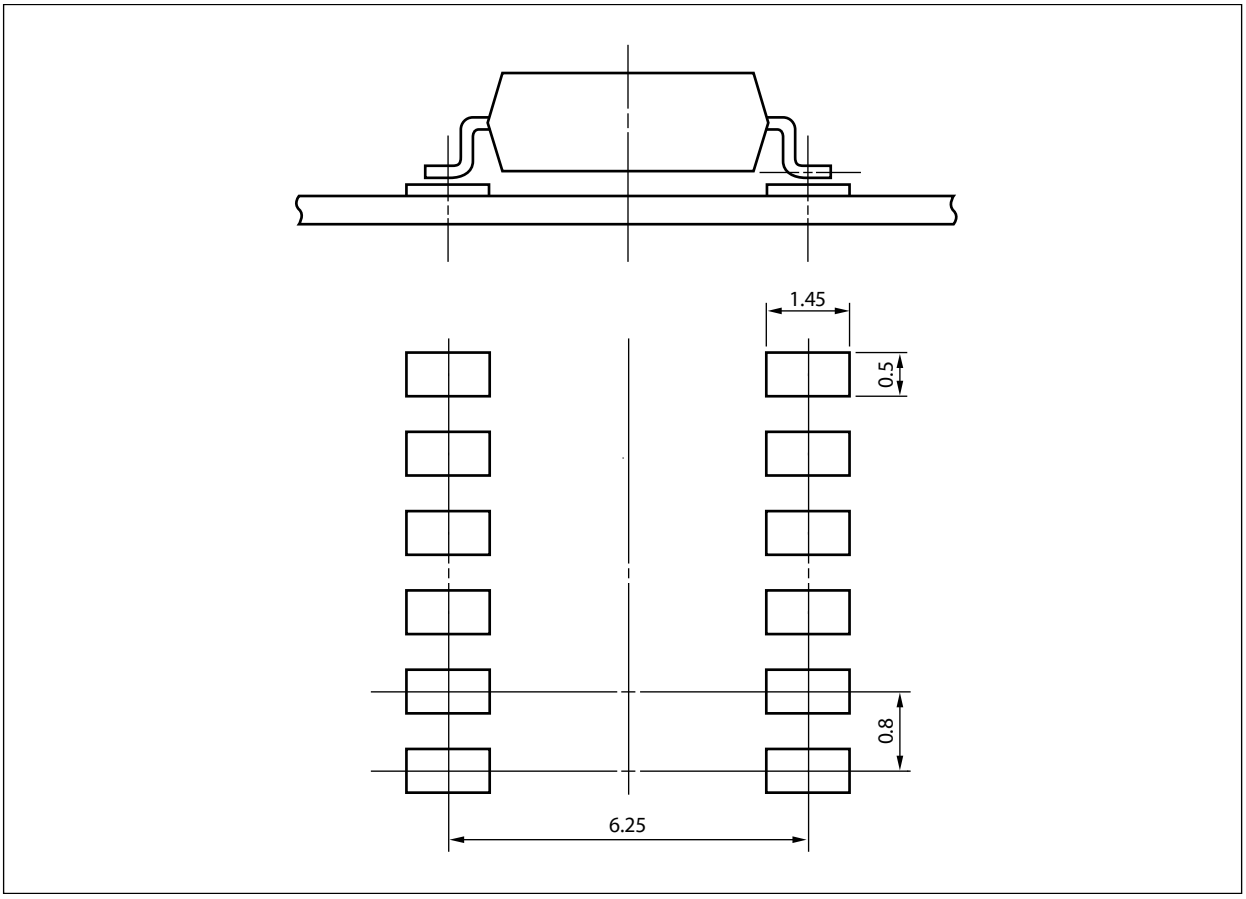


Outline and Dimensions (Reel)



Packing: 2 500 pcs/reel

RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.

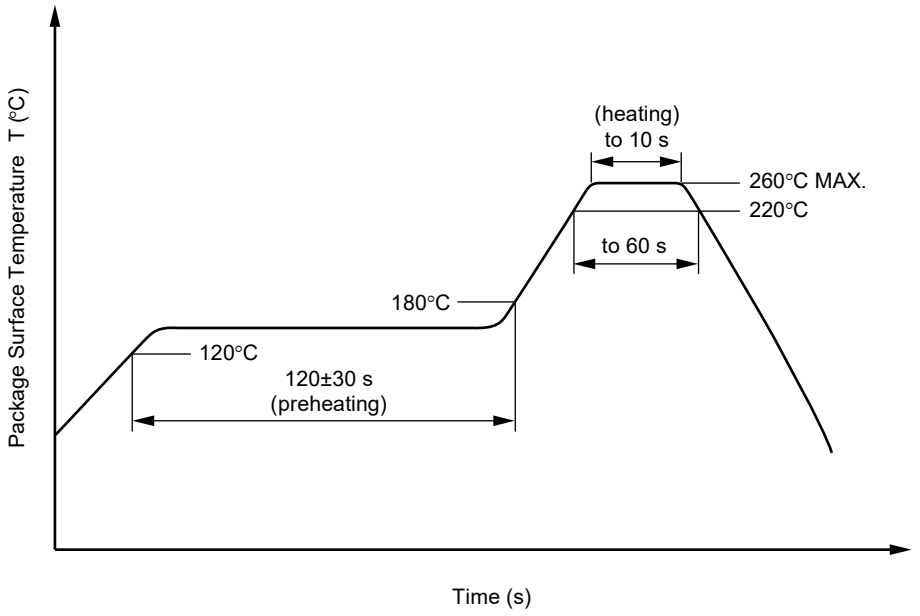
NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

• Peak reflow temperature	260°C or below (package surface temperature)
• Time of peak reflow temperature	10 seconds or less
• Time of temperature higher than 220°C	60 seconds or less
• Time to preheat temperature from 120 to 180°C	120±30 s
• Number of reflows	Three
• Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature	260°C or below (molten solder temperature)
• Time	10 seconds or less
• Preheating conditions	120°C or below (package surface temperature)
• Number of times	One (Allowed to be dipped in solder including plastic mold portion.)
• Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

• Peak Temperature (lead part temperature)	350°C or below
• Time (each pins)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

• Flux Cleaning

Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.

• Do not use fixing agents or coatings containing halogen-based substances.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

USAGE CAUTIONS

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.
3. Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.
4. Do not use fixing agents or coatings containing halogen-based substances.

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points. • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. • Do not burn, destroy, cut, crush, or chemically dissolve the product. • Do not lick the product or in any way allow it to enter the mouth.

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(Rev.4.0-1 November 2017)

RENESAS

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Renesas Electronics Corporation
TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan

Renesas Electronics America Inc.
1001 Murphy Ranch Road, Milpitas, CA 95035, U.S.A.
Tel: +1-408-432-8888, Fax: +1-408-434-5351

Renesas Electronics Canada Limited
9251 Yonge Street, Suite 8309 Richmond Hill, Ontario Canada L4C 9T3
Tel: +1-905-237-2004

Renesas Electronics Europe GmbH
Arcadiastrasse 10, 40472 Düsseldorf, Germany
Tel: +49-211-6503-0, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
Room 101-T01, Floor 1, Building 7, Yard No. 7, 8th Street, Shangdi, Haidian District, Beijing 100085, China
Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.
Unit 301, Tower A, Central Towers, 555 Langao Road, Putuo District, Shanghai 200333, China
Tel: +86-21-2226-0888, Fax: +86-21-2226-0999

Renesas Electronics Hong Kong Limited
Unit 1601-1611, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong
Tel: +852-2265-6688, Fax: +852 2886-9022

Renesas Electronics Taiwan Co., Ltd.
13F, No. 363, Fu Shing North Road, Taipei 10543, Taiwan
Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd.
80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre, Singapore 339949
Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd.
Unit No 3A-1 Level 3A Tower 8 UOA Business Park, No 1 Jalan Pengaturcara U1/51A, Seksyen U1, 40150 Shah Alam, Selangor, Malaysia
Tel: +60-3-5022-1288, Fax: +60-3-5022-1290

Renesas Electronics India Pvt. Ltd.
No.777C, 100 Feet Road, HAL 2nd Stage, Indiranagar, Bangalore 560 038, India
Tel: +91-80-67208700

Renesas Electronics Korea Co., Ltd.
17F, KAMCO Yangjae Tower, 262, Gangnam-daero, Gangnam-gu, Seoul, 06265 Korea
Tel: +82-2-558-3737, Fax: +82-2-558-5338

Colophon 8.0